



深圳市博鹏发电子科技有限公司
SHENZHEN RF-LINK ELEC&TECHNOLOGY CO.,LTD

SPECIFICATION

**IEEE 802.11 b/g/n 2.4GHz 1T1R WiFi with Bluetooth2.1
/3.0/4.0,with SDIO INTERFACE, and HS-UART MIXED INTERFACE**

**RL-SM02BD (Realtek RTL8723BS)
Combo Module**

Version 1.3



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1. PRODUCT DESCRIPTION

SM02BD is a small size and low profile of WiFi+BT combo module with LGA (Land-Grid Array) footprint, board size is 12mm*12mm with module height of 1.6mm. It can be easily manufactured on SMT process and highly suitable for tablet PC, ultra book, mobile device and consumer products. It provides GSPI/SDIO interface for WiFi to connect with host processor and high speed UART interface for BT. It also has a PCM interface for audio data transmission with direct link to external audio codec via BT controller. The WiFi throughput can go up to 150Mbps in theory by using 1x1 802.11n b/g/n MIMO technology and Bluetooth can support BT2.1+EDR/BT3.0 and BT4.0.

SM02BD uses Realtek RTL8723BS, a highly integrated WiFi/BT single MODULE based on advanced COMS process. RTL8723BS integrates whole WiFi/BT function blocks into a chip, such as SDIO/UART, MAC, BB, AFE, RFE, PA, EEPROM and LDO/SWR, except fewer passive components remained on PCB.

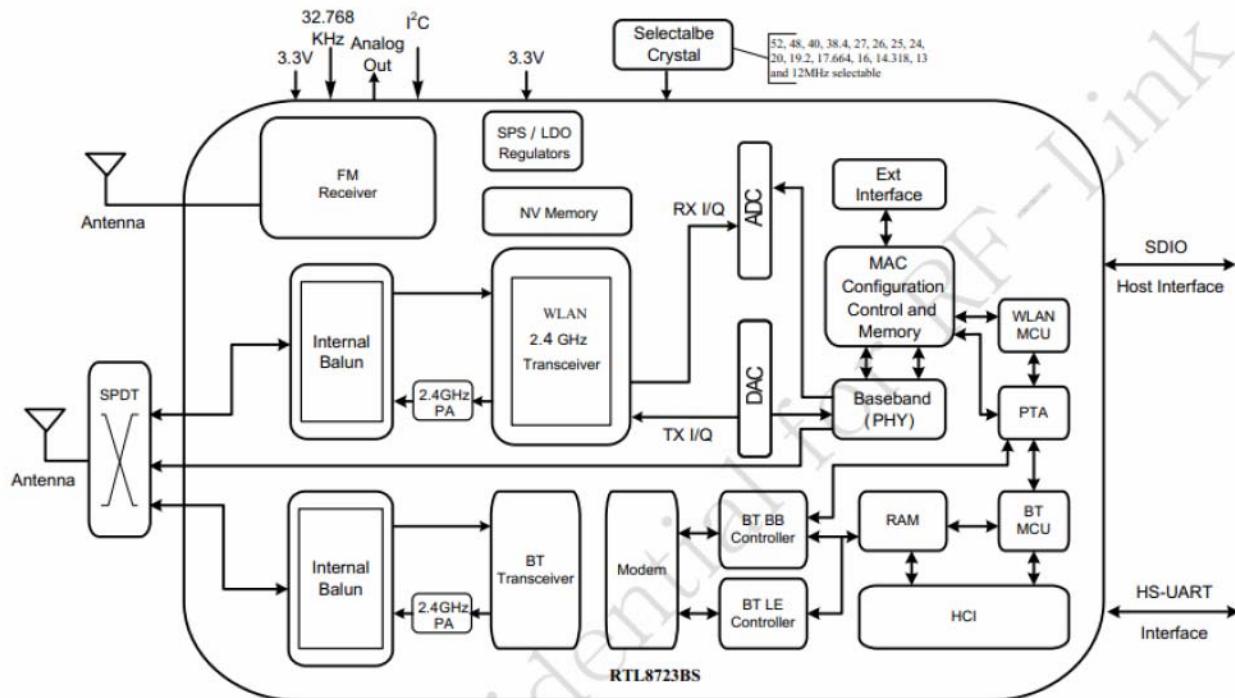
2. PRODUCT FEATURES

- ◆ Operate at ISM frequency bands (2.4GHz)
- ◆ GSPI/SDIO for WiFi and UART for Bluetooth
- ◆ IEEE standards support: IEEE 802.11b, IEEE 802.11g, IEEE 802.11n, IEEE 802.11d, IEEE 802.11e, IEEE 802.11h, IEEE 802.11i
- ◆ Fully Qualified for Bluetooth 2.1 + EDR specification including both 2Mbps and 3Mbps modulation mode
- ◆ Fully qualified for Bluetooth 3.0
- ◆ Fully qualified for Bluetooth 4.0 Dual mode
- ◆ Full -speed Bluetooth operation with Piconet and Scatternet support.
- ◆ Enterprise level security which can apply WPA/WPA2 certification for WiFi.
- ◆ WiFi 1 transmitter and 1 receiver allow data rates supporting up to 150 Mbps downstream and 150 Mbps upstream PHY rates
- ◆ For WiFi/BT, it uses fixed path for WiFi and BT, which means one antenna assigned for WiFi and the other is assigned for BT.
- ◆ Support Bluetooth adaptive power management mechanism
- ◆ Full-featured software utility for easy configuration and management
- ◆ RoHS compliance
- ◆ Low Halogen compliance



3.Diagram

Support 26Mhz



4.Temperature Limit Ratings

Parameter	Minimum	Maximum	Units
Storage Temperature	-20	70	°C
Ambient Operating Temperature	0	60	°C
Junction Temperature	0	125	°C

5.PRODUCT SPECIFICATIONS

Main chipset : WiFi/BT Single Chip: Realtek RTL8723BS
 Functional Specifications

Standards	WiFi: IEEE 802.11b, IEEE 802.11g, IEEE 802.11n, IEEE 802.11d, IEEE 802.11e, IEEE 802.11h, IEEE 802.11i BT: V2.1+EDR/BT v3.0/BT v3.0+HS/BT v4.0
Bus Interface	WiFi: GSPI/SDIO BT: UART
Data Rate	802.11b: 11, 5.5, 2, 1 Mbps 802.11g: 54, 48, 36, 24, 18, 12, 9, 6 Mbps 802.11n: MCS 0 to 7 for HT20MHz ;MCS 0 to 7 for HT40MHz BT: 1 Mbps for Basic Rate 2.3 Mbps for Enhanced Data Rate 6,9,12,18,24,36,48,54 Mbps for High Speed
Media Access Control	WiFi: CSMA/CA with ACK BT: AFH, Time Division
Modulation Techniques	802.11b: CCK, DQPSK, DBPSK 802.11g: 64 QAM, 16 QAM, QPSK, BPSK 802.11n: 64 QAM, 16 QAM, QPSK, BPSK BT: 8DPSK, $\pi/4$ DQPSK, GFSK
Network Architecture	WiFi: Ad-hoc mode (Peer-to-Peer) Infrastructure mode Software AP WiFi Direct BT: Pico Net Scatter Net
Operating Channel	WiFi 2.4GHz: 11: (Ch. 1-11) – United States 13: (Ch. 1-13) – Europe 14: (Ch. 1-14) – Japan BT 2.4GHz: Ch. 0 ~78
Frequency Range	2.400GHz ~ 2.4835 GHz
Transmit Output Power – 1x1	BT: Max +10dBm
Receiver Sensitivity	BT: -89dBm@1Mbps, -85dBm@2Mbps, -83dBm@3Mbps
Security	WiFi : WPA, WPA-PSK, WPA2, WPA2-PSK, WEP 64bit & 128bit, IEEE 802.11x, IEEE 802.11i BT: Simple Paring
OS supported	Linux/Android



6. Power Supply DC Characteristics

Symbol	Parameter	Minimum	Typical	Maximum	Units
VBAT_LDO_IN	Battery Supply Voltage	2.8	3.7~5	5.5	V
VA33, VD33IO,SW_HV3, FM_VDD_HV	3.3V Supply Voltage	3.0	3.3	3.6	V
VDD_IO,VIO_FM,VDIO_SDIO	Digital IO Supply Voltage	1.62	1.8~3.3	3.6	V
VA12, VA12_BT,VA12_WLG, VD12D	1.2V Core Supply Voltage	1.08	1.2	1.32	V
IDD33	3.3V Rating Current	-	-	600	mA

DC Characteristics

Module	Voltage	Current Consumption (linking)
RL-SM02BD-8723BS-V1.3	3.3V	

7. Electrical Specifications

1) RF Characteristics for IEEE802.11b (11Mbps mode unless otherwise specified)

Items	Contents			
Specification	IEEE802.11b			
Mode	CCK 11 Mbps			
Channel frequency	2412 ~ 2484 MHz			
RX (per≤85 dBm@8%)	-85 dBm			
Freq.Error(±13ppm)	±13 ppm			
TX Characteristics	Min.	Typ.	Max.	Unit
Power Level (17±2 dBm)		17		dBm
EVM (≤-18)		-18		dB

2) RF Characteristics for IEEE802.11g (54Mbps mode unless otherwise specified)

Items	Contents			
Specification	IEEE802.11g			
Mode	OFDM 54 Mbps			
Channel frequency	2412 ~ 2484 MHz			
RX (per≤70 dBm@10%)	-70 dBm			
Freq.Error(±13ppm)	±13 ppm			
TX Characteristics	Min.	Typ.	Max.	Unit
Power Level (14±2dBm)		14		dBm
EVM (≤-27)		-27		dB



3) RF Characteristics for IEEE802.11n (HT20_MCS7)

Items	Contents			
Specification	IEEE802.11n (HT20_MCS7)			
Mode	65 Mbps			
Channel frequency	2412 ~ 2484 MHz			
RX (per≤65 dBm@10%)	-65 dBm			
Freq.Error(±13ppm)	±13 ppm			
TX Characteristics	Min.	Typ.	Max.	Unit
Power Level (13±2 dBm)		13		dBm
EVM (≤-28)		-28		dB

4) RF Characteristics for IEEE802.11n (HT40_MCS7)

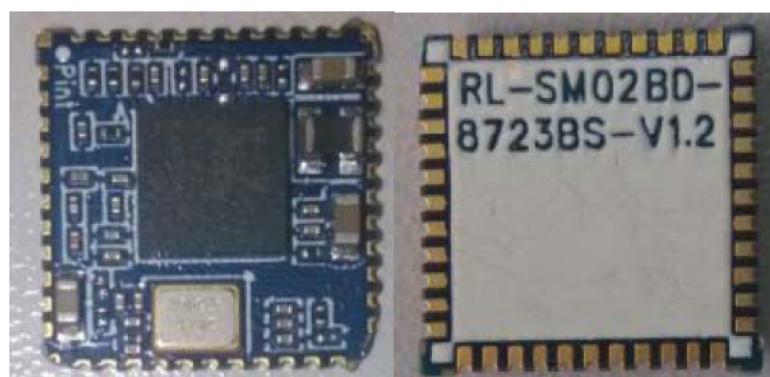
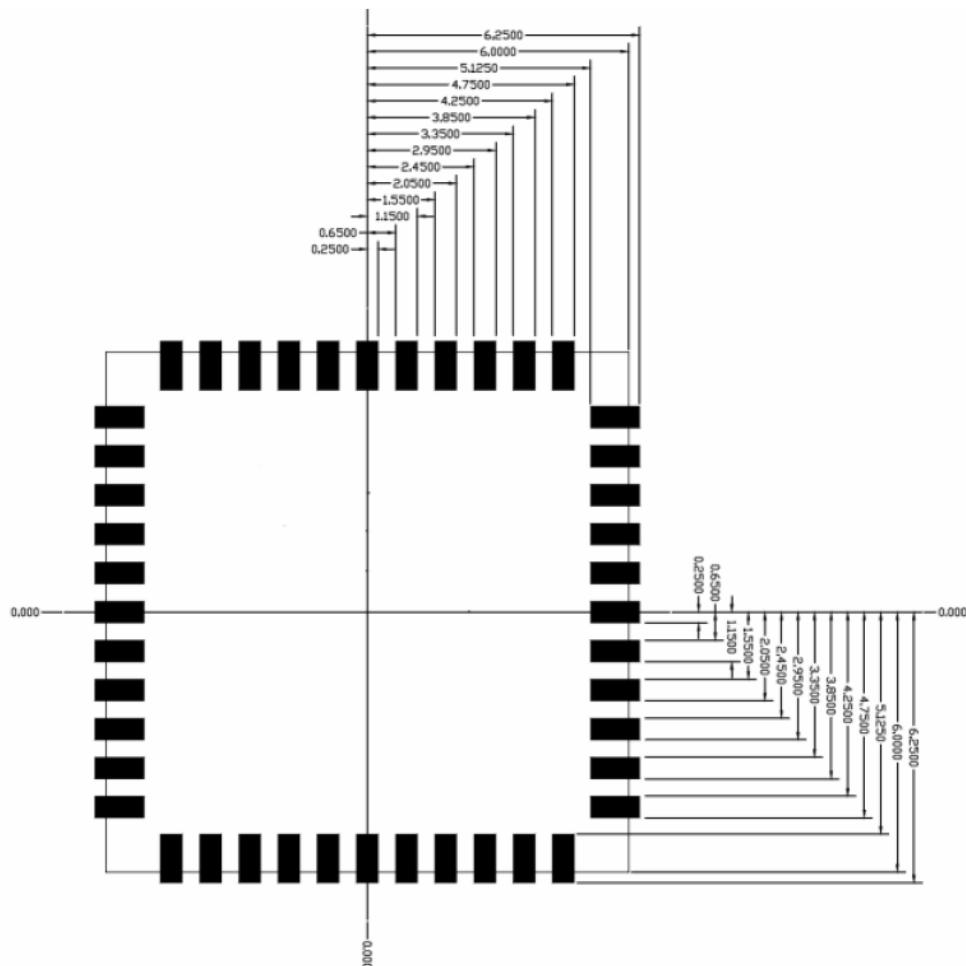
Items	Contents			
Specification	IEEE802.11n (HT40_MCS7)			
Mode	135 Mbps			
Channel frequency	2412 ~ 2484 MHz			
RX (per≤65 dBm@10%)	-65 dBm			
Freq.Error(±13ppm)	±13 ppm			
TX Characteristics	Min.	Typ.	Max.	Unit
Power Level (13±2 dBm)		13		dBm
EVM (≤-28)		-28		dB



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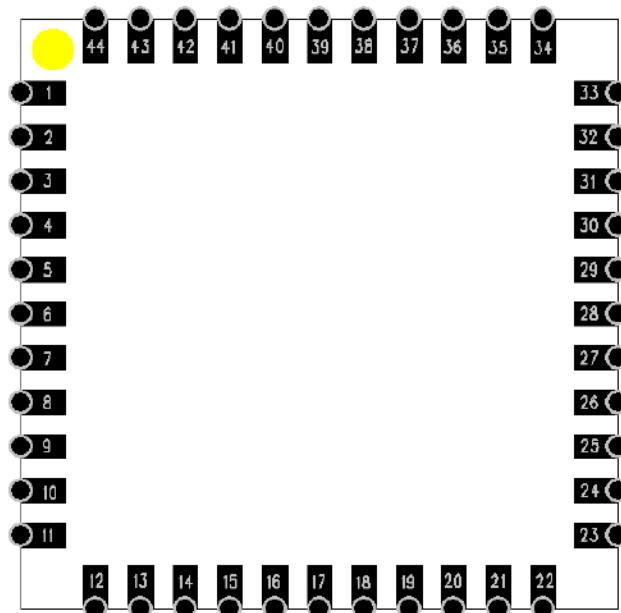
8.Mechanical

Dimensions (mm)	Length	Width	Height
	12 (Tolerance: ± 0.2 mm)	12 (Tolerance: ± 0.2 mm)	1.6 (Tolerance: ± 0.2 mm)





9. MODULE PIN ASSIGNMENT



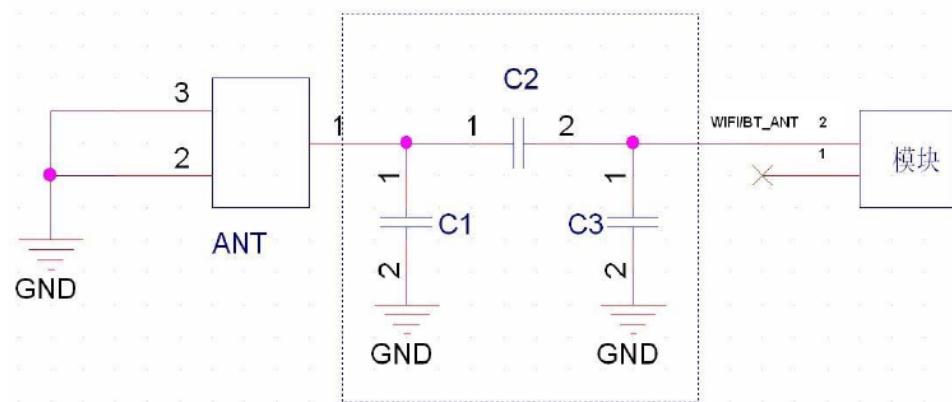
PIN	Function	Description
1	GND	Grond
2	WIFI/BT_ANT	WIFI/BT_ANT
3	NC	NC
4	NC	NC
5	NC	NC
6	BT_WAKE	HOST wake-up Bluetooth device
7	BT_HOST_WAKE	Bluetooth device to wake-up HOST
8	NC	NC
9	VABT	3.3V
10	NC	NC
11	NC	NC
12	WL_DSI#	Shared with GPIO9 This Pin Can Externally Shutdown the RTL8723BS WLAN function when BT_DISn is Pulled Low. When this pin deasserted, SDIO interface will be disabled. This pin can also support the WLAN Radio-off function with host interface remaining connected.
13	WL_HOST_WAKE	WLAN to wake-up HOST
14	SD_D2	SDIO data line 2
15	SD_D3	SDIO data line 3
16	SD_CMD	SDIO command line



17	SD_CLK	SDIO CLK line
18	SD_D0	SDIO data line 0
19	SD_D1	SDIO data line 1
20	GND	Ground
21	NC	NC
22	VDD_IO	1.8V / 3.3V
23	NC	NC
24	SUSCLK_IN	Shared with GPIO6. External 32K or RTC clock input with 1.8V ~ 3.3V swing. This clock source is configured by BT and WL FW, respectively.
25	PCM_DOUT	PCM Data output
26	PCM_CLK	PCM Clock
27	PCM_DIN	PCM data input
28	PCM_SYNC	PCM sync signal
29	NC	NC
30	NC	NC
31	GND	Ground
32	NC	NC
33	GND	Ground
34	BT_DIS#	General Purpose Input/Output Pin
35	NC	NC
36	GND	Ground
37	NC	NC
38	NC	NC
39	NC	NC
40	NC	NC
41	GND	Ground
42	UART_OUT	HOST Data output
43	UART_IN	HOST Data input
44	UART_CTS	HOST_CTS



10.WIFI\BT RF Circuit reference pictures

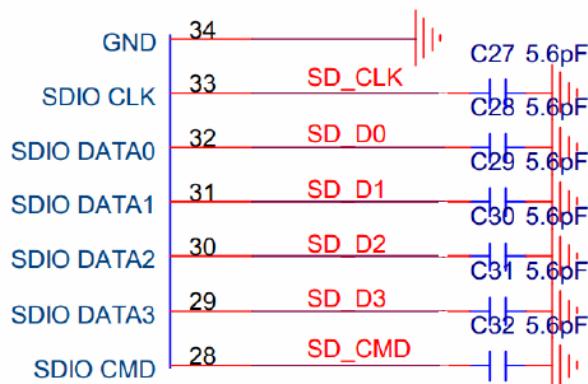


注:1.以上虚线框的部分需要进行天线匹配,以实际天线匹配的电子元器件参数为准.

2.以上为 RF 走线要做 50 欧姆阻抗,走线不能走 90 度,走线长度不能超过 15mm.

Note: The RF part layout must do 50Ω impedance., can't get the line go 90° , can't get the line longer than 15 mm.

11.SDIO interface Circuit reference pictures



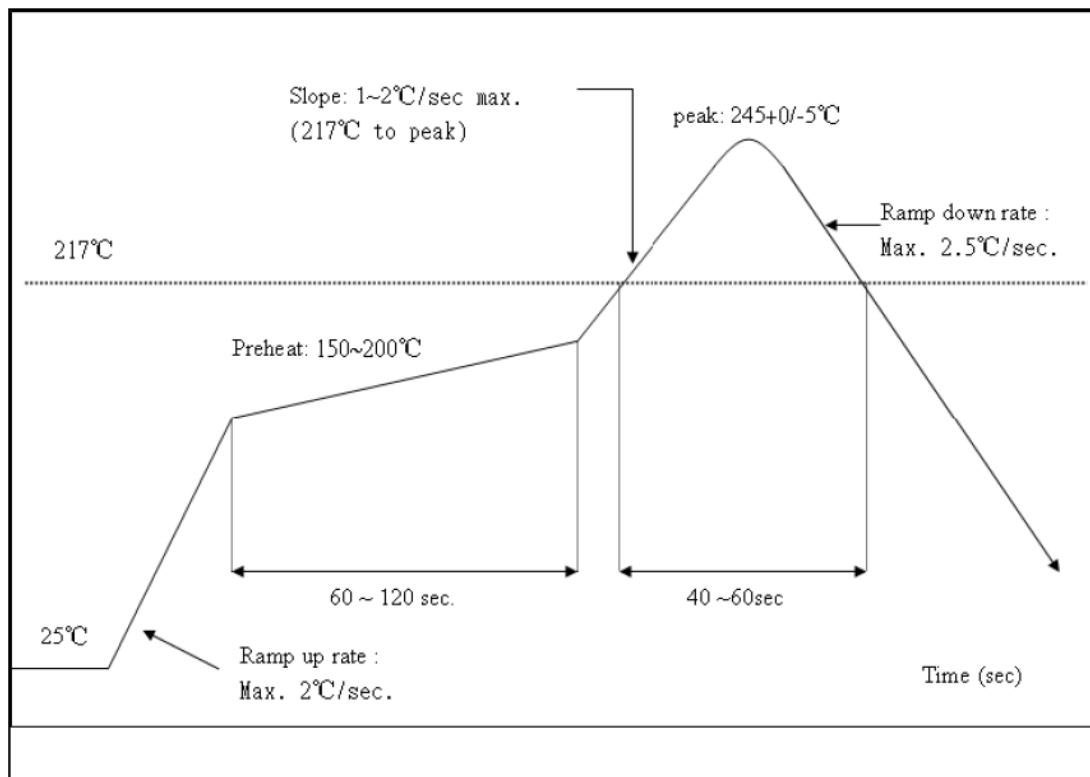


12. Recommended Reflow Profile

Referred to IPC/JEDEC standard.

Peak Temperature : <250°C

Number of Times : ≤2 times



ENVIRONMENTAL

Operating

Operating Temperature: 0°C to +70 °C

Relative Humidity: 5-90% (non-condensing)

Storage

Temperature: -40°C to +80°C (non-operating)

Relevant Humidity: 5-95% (non-condensing)

MTBF calculation

Over 150,000hours



13. Wireless module before the SMT note:

1. When customers Open stencil must be sure the hole bigger to the Wireless module plate, please press 1 to 1 and 0.7 mm is widened to open outward, the thickness of 0.12 mm.
2. Can't get the wifi module bare hands when needs, must we wear the gloves and static ring.
3. The furnace temperature according to the size of the customer the mainboard, generally like to stick on a tablet standard temperature of 250 + - 5, can do 260 + - 5.

Storage and use Wifi module control should pay attention to the following matters:

1. Module of the storage life of vacuum packaging:

1-1. Storage life: 12 months. Storage conditions: <40°C, Relative humidity: <90%R.H.

1-2. After this bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing must be:

1-3. Check the humidity card stored at $\leq 20\%$ R.H. If $30\% \sim 40\%$ (pink) or greater than 40% (red). Labeling module has moisture absorption.

① Mounted within 168 hours at factory conditions of $t \leq 30^\circ\text{C}$, $\leq 60\%$ R.H.

② Once opened, the workshop the preservation of life for 168 hours.

1-4. If baking is required, devices may be baked for:

- ① Modules must be to remove module moisture problem.
- ② Baking temperature: 125°C , 8 hours.

③ After baking, put proper amount of desiccant to seal packages.

1-5. The actual number of module vacuum packing which is based on the actual number of packages to the customer requirements, vacuum packing of picture<1>

2. Module reel packaging items as follows:

2-1. Storage life: 12 months. Storage conditions: <40°C, Relative humidity: <90%R.H.

2-2. Module apart packing after 168 hours, To launch patch need to bake, to remove the module hygroscopic, baking temperature conditions: 125°C , 8 hours.

2-3. The actual number of module reel packing which is based on the actual number of packages to the customer requirements, Reel packing of picture<2>

3. Module pallet packaging items as follows:

3-1. Storage life: 3 months. Storage conditions: <40°C, Relative humidity: <90%R.H.

3-2. Module if not used within 48 hours, before launch the need for

13. WiFi 模块贴片装机前注意事项:

1. 客户在开钢网时一定要将 WiFi 模块焊盘的孔开大, 请按 1 比 1 再向外扩大 0.7mm 比例开钢网, 厚度按 0.12mm.

2. 有需要拿 WiFi 模块时不可以光手去拿, 一定要戴上手套以及静电环.

3. 过炉温度要根据客户主板的大小而定, 一般像平板电脑上的标准温度为 $250 \pm 5^\circ$, 也可以做到 $260 \pm 5^\circ$

WiFi 模块储存及使用管制应注意事项如下:

1. 模块的真空包装之储存期限:

1-1. 保存期限: 12 个月, 储存环境条件: 温度在: $<40^\circ\text{C}$, 相对湿度: $<90\%$ R.H.

1-2. 模块包装被拆后, SMT 组装之时限:

1-3. 检查湿度卡: 显示值应小于 30% (蓝色), 如: 30%~40% (粉红色) 或者大于 40% (红色) 表示模块已吸湿气.

① 工厂环境温度湿度管制: $\leq 30^\circ\text{C}$, $\leq 60\%$ R.H.

② 拆封后, 车间的保存寿命为 168 小时.

1-4. 如在拆封后的 168 个小时内未使用完, 需要烘烤, 烘烤条件如下:

① 模块须重新烘烤, 以除去模块吸湿问题.

② 烘烤温度条件: 125°C , 8 小时.

③ 烘烤后, 放入适量的干燥剂再密封包装.

1-5. 模块真空包装数量以客户要求的实际包装数量为准, 真空包装图片<1>

2. 模块卷盘包装事项如下:

2-1. 保存期限: 12 个月, 储存环境条件: 温度在: $<40^\circ\text{C}$, 相对湿度: $<90\%$ R.H.

2-2. 模块拆开包装 168 小时后, 如要上线贴片需要重新烘烤, 以除去模块吸湿问题, 烘烤温度条件: 125°C , 8 小时.

2-3. 模块卷盘包装以客户要求的实际包装数量为准, 卷盘包装图片<2>

3. 模块托盘包装事项如下:

3-1. 保存期限: 3 个月, 储存环境条件: 温度在: $<40^\circ\text{C}$, 相对湿度: $<90\%$ R.H.

3-2. 模块如在 48 小时内未使用, 在上线之前需要进行烘烤, 烘烤温度条件: 125°C , 8 小时.

3-3. 托盘包装每盘为 100pcs, 模块托盘包装以客户要求的实际包装数量为准.

注: 以上包装方式根据客户要求而定, 包装以实际出货为准.



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baking, baking temperature: 125 °C, 8 hours.

3-3. Pallet packaging each plate is 100 PCS. The actual number of module pallet packing which is based on the actual number of packages to the customer requirements.

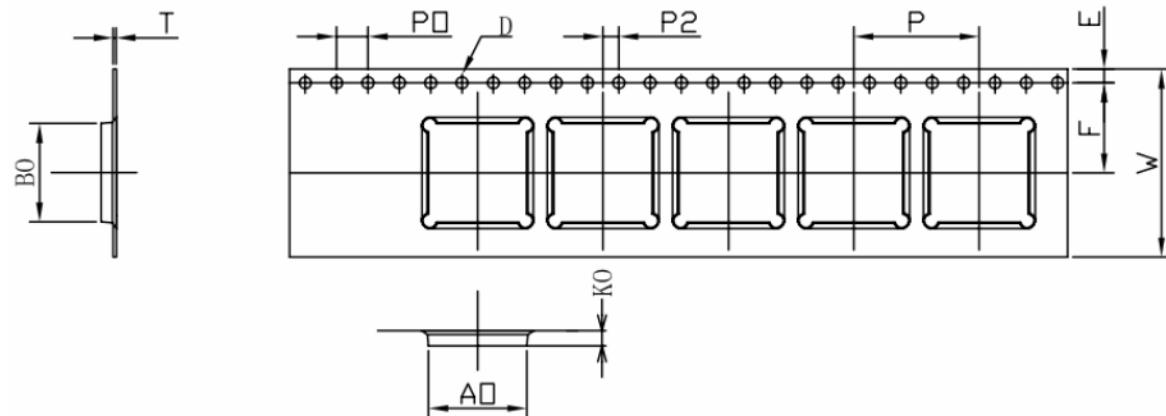


Picture<1>



Picture<2>

ITEM	W	A0	B0	D	F	E	K0	P0	P2	P	T
DIM	24	12.56	12.56	1.50	11.5	1.75	1.95	4.0	2.0	16.0	0.30
TOLE	+0.3 -0.3	±0.10	±0.10	+0.1 -0.0	+0.1 -0.1	±0.1	±0.10	±0.1	±0.1	±0.1	±0.05



Picture<2>

FCC Statement

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.

Consult the dealer or an experienced radio/TV technician for help

This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

The minimum separation generally be used is at least 20cm, even if the calculation indicate that the MPE distance would be lesser.

IMPORTANT NOTE:

This device is intended only for OEM integrators under the following conditions:

- (1) According to FCC Part 15 Subpart C Section 15.212, the radio elements of the modular transmitter must have their own shielding. However, due to there is no shielding for this WiFi Module, this module is granted as a Limited Modular Approval.
- (2) This device has been designed to operate with a integral antenna built-in the base board having a maximum gain of 0dBi. Only this type of antenna may be used.
- (3) Integration is typically strictly restricted to Grantee himself or dedicated OEM integrators under control of the Grantee.

As long as 3 conditions above are met, further transmitter test will not be required.

However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).



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IMPORTANT NOTE:

In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

IMPORTANT NOTE:

This module is intended for OEM integrator only and the OEM integrators are instructed to ensure that the end user has no manual instructions to remove or install the device. The OEM integrator is still responsible for the FCC compliance requirement of the end product, which integrates this module.

LABEL OF THE END PRODUCT:

The final end product must be labeled in a visible area with the following "Contains TX FCC ID: 2AAH78723BSV13". If the size of the end product is smaller than 8*10 cm, then additional FCC part 15.19 statement is required to be available in the users' manual: This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.